- Low-Power Version of SN74ALS240A
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

### description

This octal buffer and line driver is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and

10E 20 VCC 1A1 🛮 2 19 20E 2Y4 🛮 3 18**∏** 1Y1 1A2 🛮 2A4 2Y3 [ 5 **∏** 1Y2 16 1A3 **[**] 6 15 **1** 2A3 2Y2 **1**7 14 1 1Y3 1A4 **∏** 8 13**∏** 2A2 2Y1 **∏** 9 12 1 1Y4 GND [] 10 11 2A1

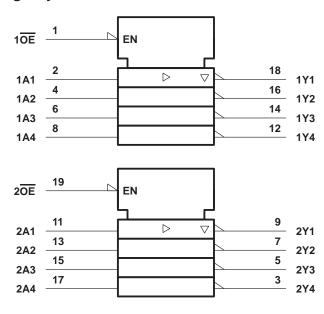
DW OR N PACKAGE

(TOP VIEW)

transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable  $(\overline{OE})$  inputs, and complementary OE and  $\overline{OE}$  inputs. This device features high fan-out and improved fan-in.

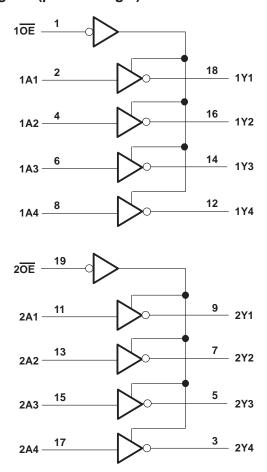
The SN74ALS1240 is characterized for operation from 0°C to 70°C.

### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





SDAS054B - DECEMBER 1982 - REVISED JANUARY 1995

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, TA	0°C to 70°C
	-65°C to 150°C

### recommended operating conditions

		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
IOH	High-level output current			-15	mA
l <sub>OL</sub>	Low-level output current			16	mA
TA	Operating free-air temperature	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST COND	ITIONS	MIN	TYP <sup>‡</sup>	MAX	UNIT
VIK	V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			
VOH	V <sub>CC</sub> = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V
	∨CC = 4.5 ∨	$I_{OH} = -15 \text{ mA}$	2			
Va	V <sub>CC</sub> = 4.5 V	$I_{OL} = 8 \text{ mA}$		0.25	0.4	V
VOL		I <sub>OL</sub> = 16 mA		0.35	0.5	
lozн	$V_{CC} = 5.5 V,$	V <sub>O</sub> = 2.7 V			20	μΑ
lozl	$V_{CC} = 5.5 V,$	V <sub>O</sub> = 0.4 V			-20	μΑ
l <sub>l</sub>	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 7 V			0.1	mA
Ι <sub>ΙΗ</sub> §	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20	μΑ
Ι <sub>Ι</sub> L§	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 0.4 V			-0.1	mA
IO¶	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-30		-112	mA
	V <sub>CC</sub> = 5.5 V	Outputs high		5	8	
Icc		Outputs low		8.5	14	mA
		Outputs disabled		8.1	13	

 $<sup>\</sup>frac{1}{4}$  All typical values are at  $V_{CC} = 5$  V,  $T_A = 25$ °C.



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>§</sup> For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current.

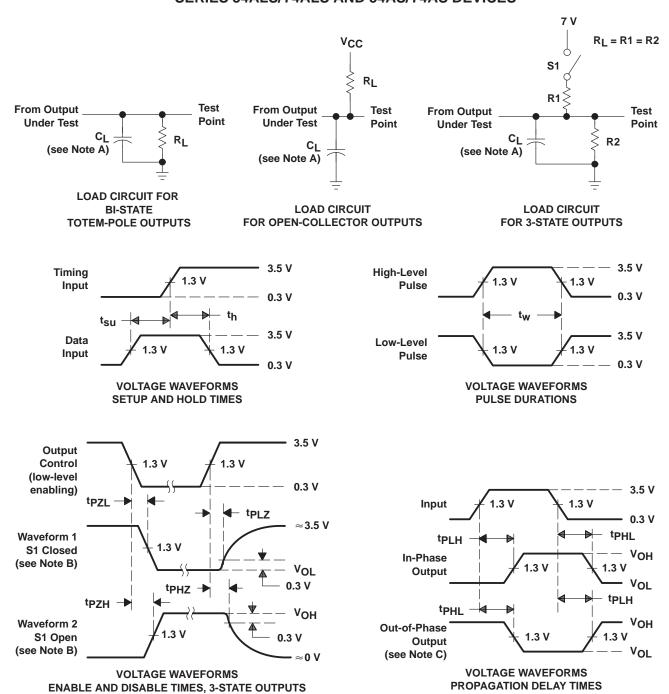
<sup>1</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$ = 4.5 $\Omega$ $C_L$ = 50 pF $R1$ = 500 $\Omega$ $R2$ = 500 $\Omega$ $T_A$ = MIN to	UNIT	
			MIN	MAX	
<sup>t</sup> PLH	А		2	13	ns
<sup>t</sup> PHL	ζ.	Y	2	13	
<sup>t</sup> PZH	ŌĒ	٧	4	20	ns
<sup>t</sup> PZL	OE .	Y	6	22	115
<sup>t</sup> PHZ	ŌĒ	V	2	10	ns
t <sub>PLZ</sub>	OL	1	3	13	115

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
  - D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_f = t_f = 2$  ns, duty cycle = 50%.
  - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







24-Jun-2005

### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74ALS1240-1N	OBSOLETE	PDIP	N	20	TBD	Call TI	Call TI
SN74ALS1240DW	OBSOLETE	SOIC	DW	20	TBD	Call TI	Call TI
SN74ALS1240DWR	OBSOLETE	SOIC	DW	0	TBD	Call TI	Call TI
SN74ALS1240N	OBSOLETE	PDIP	N	20	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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